

# **N-Channel Enhancement Mode Power MOSFET**

#### **Description**

The GT023N10Q uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge. It can be used in a wide variety of applications.

#### **General Features**

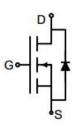
 $ullet V_{DS} = 100V$   $ullet I_D (at V_{GS} = 10V) = 226A$   $ullet R_{DS(ON)} (at V_{GS} = 10V) = 2.7mΩ$ 

• 100% Avalanche Tested

RoHS Compliant

#### **Application**

- Power switch
- DC/DC converters



Schematic diagram



TO-247

### **Ordering Information**

Device	Package	Marking	Packaging
GT023N10Q	TO-247	GT023N10	30pcs/Tube

<b>Absolute Maximum Ratings</b> $T_C = 25^{\circ}C$ , unless otherwise noted					
Parameter	Symbol	Value	Unit		
Drain-Source Voltage	V <sub>DS</sub>	100	٧		
Continuous Drain Current	I <sub>D</sub>	226	А		
Pulsed Drain Current (note1)	I <sub>DM</sub>	904	А		
Gate-Source Voltage	$V_{GS}$	±20	V		
Power Dissipation	P <sub>D</sub>	250	W		
Single pulse avalanche energy (note2)	E <sub>AS</sub>	600	mJ		
Operating Junction and Storage Temperature Range	$T_J,T_stg$	-55 To 175	°C		

Thermal Resistance					
Parameter	Symbol	Value	Unit		
Thermal Resistance, Junction-to-Ambient	R <sub>thJA</sub>	62	°C/W		
Maximum Junction-to-Case	R <sub>thJC</sub>	0.5	°C/W		



Specifications T <sub>J</sub> = 25°C, u	Specifications T <sub>J</sub> = 25°C, unless otherwise noted						
Parameter	Oh al	Test Conditions	Value			11.24	
	Symbol		Min.	Тур.	Max.	Unit	
Static Parameters							
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	100			V	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 100V, V_{GS} = 0V$			1	μΑ	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS}$ = $\pm 20V$			±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.0	3.0	4.0	V	
Drain-Source On-Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 80A$		2.1	2.7	mΩ	
Forward Transconductance	9 <sub>FS</sub>	V <sub>GS</sub> = 5V, I <sub>D</sub> = 80A		126		S	
Dynamic Parameters	<b>,</b>						
Input Capacitance	$C_{iss}$			8488		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0V$ , $V_{DS} = 50V$ , f = 0.5MHz		3436			
Reverse Transfer Capacitance	C <sub>rss</sub>			97			
Total Gate Charge	$Q_g$	$V_{DD} = 50V,$ $I_{D} = 80A,$ $V_{GS} = 10V$		121			
Gate-Source Charge	$Q_{gs}$			36		nC	
Gate-Drain Charge	$Q_{gd}$			26			
Turn-on Delay Time	t <sub>d(on)</sub>			24			
Turn-on Rise Time	t <sub>r</sub>	$V_{DD} = 50V$ , $I_D = 80A$ , $R_G = 5\Omega$		30			
Turn-off Delay Time	$t_{d(off)}$			94		ns	
Turn-off Fall Time	t <sub>f</sub>			74			
Drain-Source Body Diode Characteristics							
Continuous Body Diode Current	Is	T <sub>C</sub> = 25°C			226	Α	
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25°C, I <sub>SD</sub> = 80A, V <sub>GS</sub> = 0V			1.2	V	
Reverse Recovery Charge	Qrr	I <sub>F</sub> = 80A, V <sub>GS</sub> = 0V		297		nC	
Reverse Recovery Time	Trr	di/dt=100A/us		94		ns	

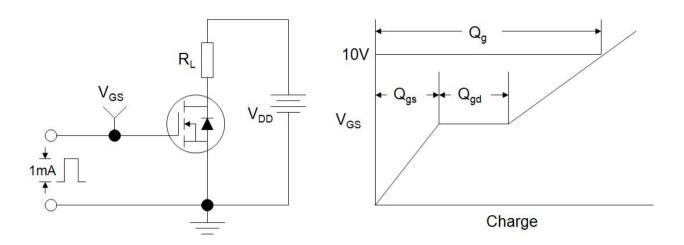
#### Notes

1. Repetitive Rating: Pulse width limited by maximum junction temperature

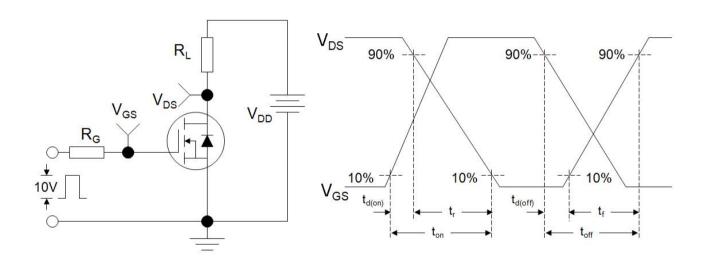
- 2. EAS condition : Tj=25°C ,VDD=50V,VGS=10V,L=0.5mH,Rg=25 $\Omega$
- 3. Identical low side and high side switch with identical  $R_{\mbox{\scriptsize G}}$



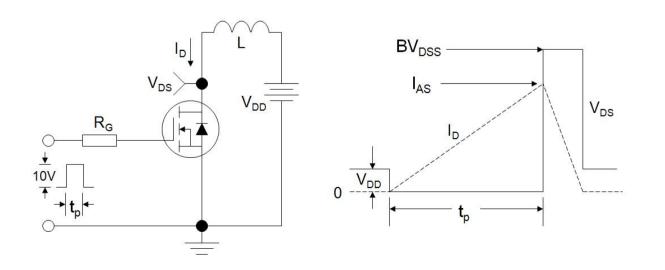
### **Gate Charge Test Circuit**



#### **Switch Time Test Circuit**



**EAS Test Circuit** 





### **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

Figure 1. Output Characteristics

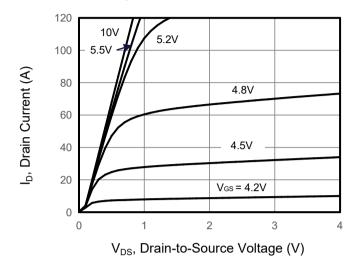


Figure 3. Drain Source On Resistance

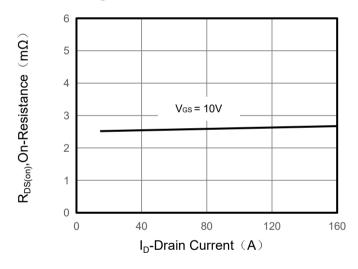


Figure 5. Capacitance

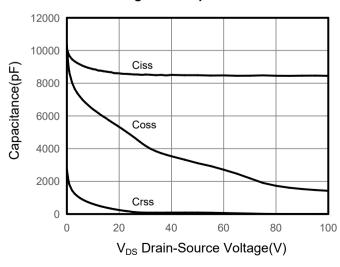


Figure 2. Transfer Characteristics

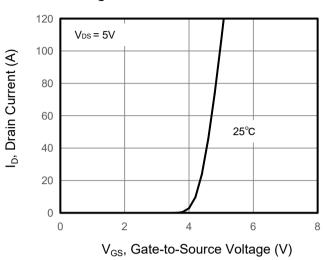


Figure 4. Gate Charge

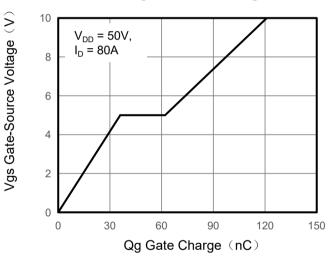
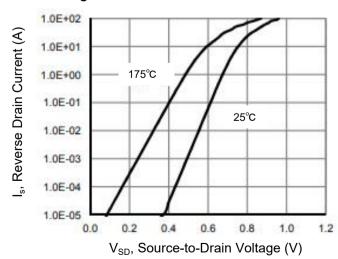


Figure 6. Source-Drain Diode Forward





# **Typical Characteristics** $T_J = 25^{\circ}\text{C}$ , unless otherwise noted

Figure 7. Drain-Source On-Resistance

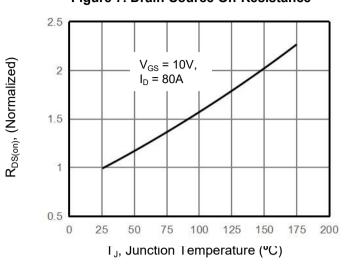


Figure 8. Safe Operation Area

10

V<sub>DS</sub>, Drain-Source Voltage(V)

100

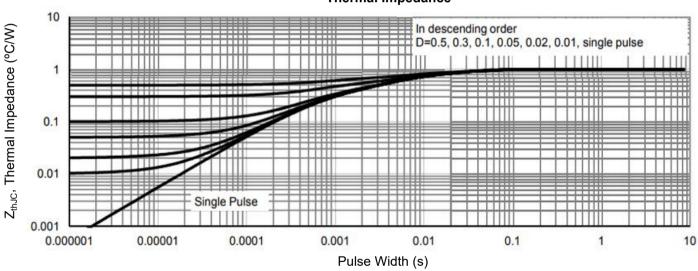
1000

Figure 9. Normalized Maximum Transient Thermal Impedance

0.01

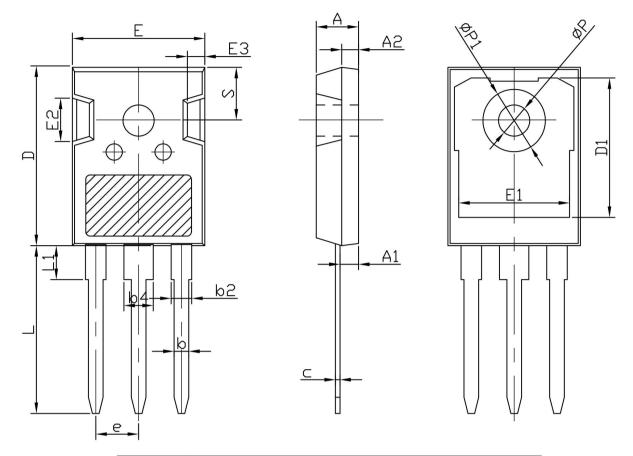
0.01

0.1





# **TO-247 Package Information**



CVMDOI	mm		
SYMBOL	MIN	NOM	MAX
A	4. 80	5. 00	5. 20
A1	2. 21	2.41	2. 59
A2	1.85	2.00	2. 15
b	1. 11	1. 21	1.36
b2	1. 91	2.01	2. 21
b4	2. 91	3. 01	3. 21
С	0. 51	0.61	0.75
D	20.70	21.00	21. 30
D1	16. 25	16. 55	16.85
Е	15. 50	15. 80	16. 10
E1	13.00	13. 30	13. 60
E2	4. 80	5. 00	5. 20
E3	2. 30	2. 50	2. 70
е	5. 44BSC		
L	19.62	19. 92	20. 22
L1	-	_	4. 30
<b>φ</b> P	3. 40	3. 60	3.80
<b>ø</b> P1	_	_	7. 30
S	6. 15BSC		